



PATENT  
81839.0077

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Teruaki FUKAMI

Serial No: 09/218,997

Filed: December 22, 1998

For: SILICON WAFER STORAGE WATER  
AND SILICON WAFER STORAGE  
METHOD

Date of NOA: April 13, 2004

Art Unit: 1744

TRANSMITTAL OF ISSUE FEE

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P.O. Box 1450  
Alexandria, VA 22313-1450

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Signature

Date

Dear Sir:

In response to the Notice of Allowance dated April 13, 2004, enclosed are the following:

- ☒ Form Part B - Issue Fee Transmittal and a check in the amount of \$ 1660.00 in payment of the Issue Fee, Publication Fee and in payment of the Advance Order for 10 patent copies (at \$3.00 per copy).
- ☒ An Information Disclosure Statement citing three references is being filed concurrently herewith.

The Commissioner is hereby authorized to charge any deficiency in payment or credit any overpayment to Deposit Account No. 50-1314. A copy of this Transmittal is enclosed.

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: June 1, 2004

By:

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08/10/2004 HSMITH1 00000002 501314 09218997

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Examiner: Elizabeth L. McKane

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FEE VALUE ACCOUNTABILITY	
POSIT ACCOUNT NO.	
FEE CODE	VALUE FURNISHED
186	186.

**TRANSMITTAL OF  
INFORMATION DISCLOSURE STATEMENT**

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Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sirs:

- ☐ The information disclosure statement submitted herewith is being filed within three months of the filing date of the application other than a continued prosecution application, or within three months of the date of entry into the national stage of an international application, or before the mailing date of a first Office Action on the merits, or before the mailing of a first Office action after the filing of a request for continued examination under §1.114, whichever event occurs last. 37 C.F.R. §1.97(b).
- ☐ The information disclosure statement transmitted herewith is being filed *after* the period specified in §1.97(b), but *before* the mailing date of a final action under §1.113, or a notice of allowance under §1.311, or an action that otherwise closes prosecution in the application, whichever occurs first. A statement specified in §1.97(e) or a fee set forth in §1.17(p) is included. 37 C.F.R. §1.97(c).

**§1.97(e) STATEMENT**

I, the person signing below, state:

- ☐ that each item of information contained in the information disclosure statement was first cited in the attached communication from a foreign patent office in a counterpart foreign application and that the communication is dated not more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(1).

OR

- ☐ that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart